

IR062HD4C10U-P2 IR082HD4C10U-P2

HIGH VOLTAGE HALF BRIDGE

Features

- Output Power IGBT's in half-bridge configuration
- 600V rated breakdown voltage
- High side gate drive designed for bootstrap operation
- Matched propagation delay for both channels
- Independent high and low side output channels (IR062HD4C10U-P2) or cross-conduction prevention logic (IR082HD4C10U-P2)
- Undervoltage lockout
- 5V Schmitt-triggered input logic
- Metal heatsink back for improved P_D

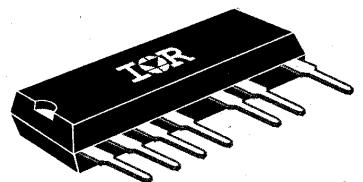
Description

The IR062HD4C10U-P2 / IR082HD4C10U-P2 are high voltage, high speed half bridges. Proprietary HVIC and latch immune CMOS technologies, along with the power IGBT technology, enable ruggedized single package construction. The logic inputs are compatible with standard CMOS or LSTTL outputs. The front-end features an independent high and low side driver in phase with the logic compatible input signals. The output features two IGBT's in a half-bridge configuration. Propagation delays for the high and low side power IGBT's are matched to simplify use. The device can operate up to 600 volts.

Product Summary

V_{IN} (max)	600V
P_D ($T_A = 25^\circ\text{C}$)	3.0W
$V_{CE(ON)}$ typ	3.0V

Package



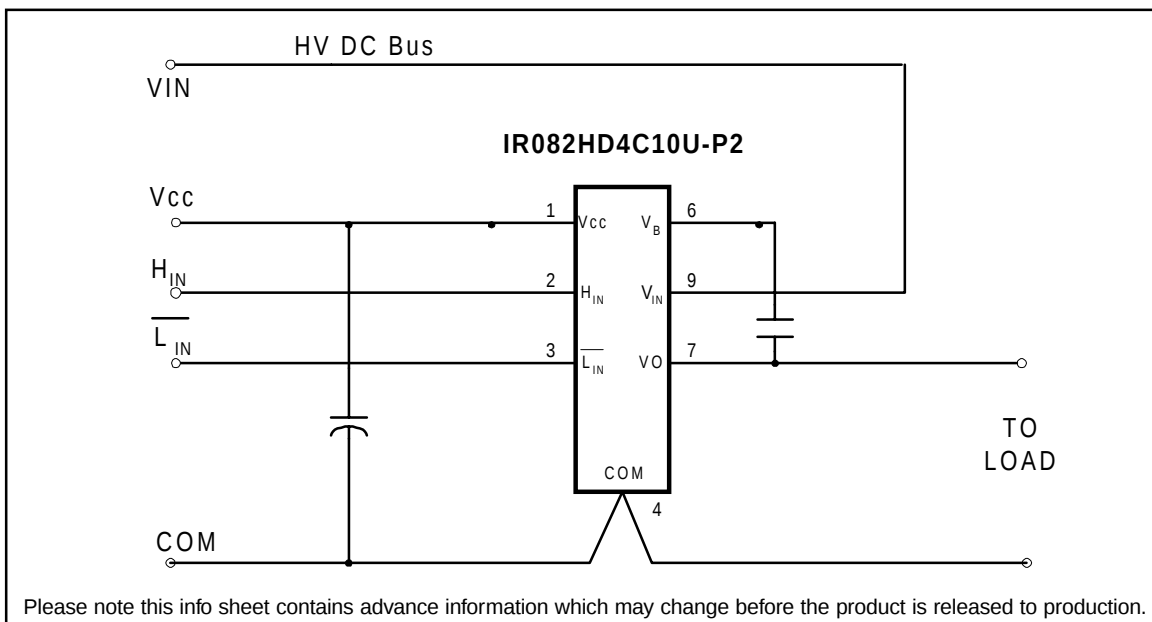
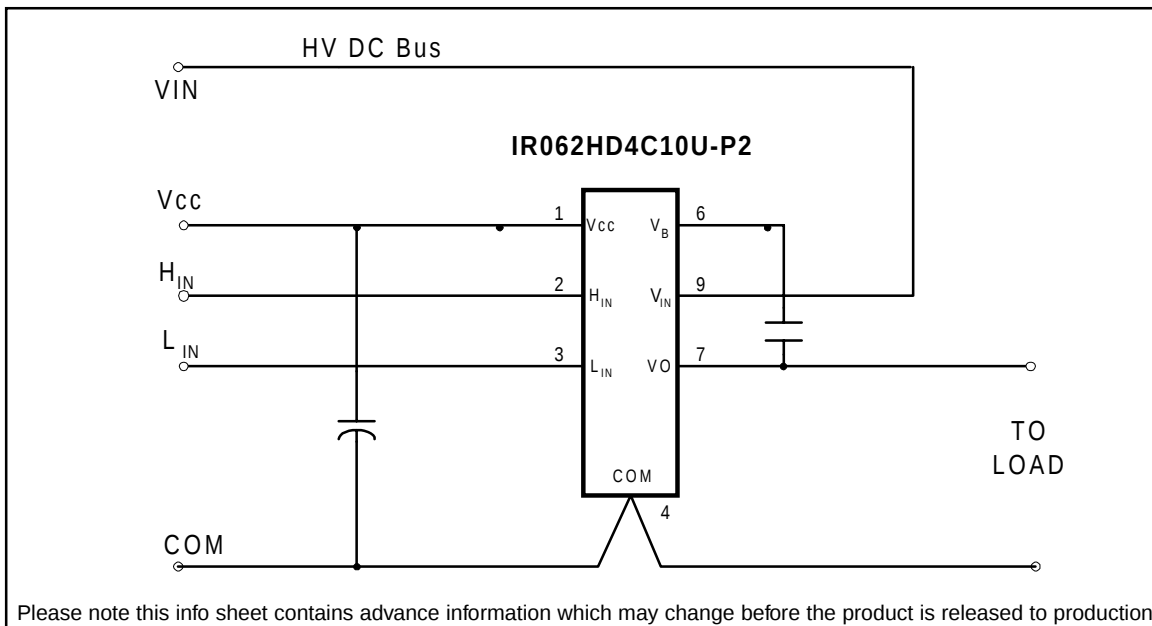
7 Pin

IR062HD4C10U-P2

IR082HD4C10U-P2

International
IOR Rectifier

Typical Connections



Absolute Maximum Ratings

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The Thermal Resistance and Power Dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
V_{IN}	High voltage supply	- 0.3	600	V
V_B	High side floating supply absolute voltage	$V_O - 0.3$	$V_O + 25$	
V_O	Half-bridge output voltage	-0.3	$V_{IN} + 0.3$	
V_{IH}/V_{IL}	Logic input voltage (HIN & LIN)	- 0.3	$V_{CC} + 0.3$	
V_{CC}	Low side and logic fixed supply voltage	-0.3	25	
dV/dt	Peak diode recovery dv/dt	—	3.50	V/ns
P_D	Package power dissipation @ $T_A \leq +25^\circ\text{C}$	—	3.00	W
R_{thJA}	Thermal resistance, junction to ambient	—	50	$^\circ\text{C}/\text{W}$
R_{thJC}	Thermal resistance, junction to case (metal)	—	20	
T_J	Junction temperature	-55	150	$^\circ\text{C}$
T_S	Storage temperature	-55	150	
T_L	Lead temperature (soldering, 10 seconds)	—	300	

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions.

Symbol	Definition	Min.	Max.	Units
V_B	High side floating supply absolute voltage	$V_O + 10$	$V_O + 20$	V
V_{IN}	High voltage supply	—	600	
V_O	Half-bridge output voltage	(note 1)	V_{IN}	
V_{CC}	Low side and logic fixed supply voltage	10	20	
V_{IH}/V_{IL}	Logic input voltage (HIN & LIN)	0	V_{CC}	
T_A	Ambient temperature	-40	125	
I_C	Continuous collector current (TC = 25 $^\circ\text{C}$)	—	2.0	A
	(TC = 85 $^\circ\text{C}$)	—	1.1	

Note 1: Logic operational for V_O of -5 to 600V. Logic state held for V_O of -5 to $-V_{BO}$

IR062HD4C10U-P2

IR082HD4C10U-P2

Dynamic Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15V and $T_A = 25^\circ\text{C}$ unless otherwise specified. Switching time waveform definitions are shown in figure 2. Refer to IC data sheets (IR2106 and IR2108) for further characteristics.

Symbol	Definition	$T_A = 25^\circ\text{C}$			Units	Test Conditions
		Min.	Typ.	Max.		
t_{on}	Turn-on propagation delay (see note 2)	-IR062	—	220	310	ns
		-IR082	—	680	900	
t_{off}	Turn-off propagation delay (see note 2)	-IR062	—	257	380	
		-IR082	—	220	400	
t_{rr}	Reverse recovery time (FRED Diode)	—	28	—	nC	$I_F = 400\text{mA}$
Q_{rr}	Reverse recovery charge (FRED Diode)	—	40	—		$di/dt = 100\text{ A/us}$

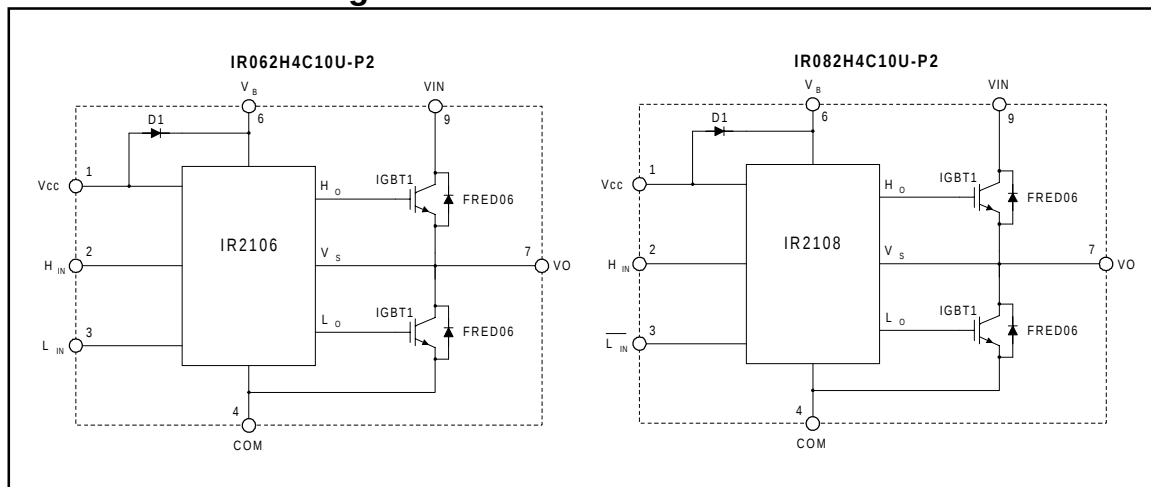
Note 2: Switching times as specified and illustrated in figure 2 are referenced to the VO output voltage. This is shown as VO in figure 2.

Static Electrical Characteristics

V_{BIAS} (V_{CC} , V_{BS}) = 15V and $T_A = 25^\circ\text{C}$ unless otherwise specified. The V_{IN} and I_{IN} parameters are referenced to COM.

Symbol	Definition	$T_A = 25^\circ\text{C}$			Units	Test Conditions
		Min.	Typ.	Max.		
V_{CCUV+} V_{BSUV+}	V_{CC} supply undervoltage positive going threshold	8.0	8.9	9.8	V	
V_{CCUV-} V_{BSUV-}	V_{CC} supply undervoltage negative going threshold	7.4	8.2	9.0		
I_{QCC}	Quiescent V_{CC} supply current	0.4	1.0	1.6	mA	
I_{QBO}	Quiescent V_{BO} supply current	20	60	150	μA	
I_{LK}	Offset supply leakage current @25°C	—	—	100		$V_B = 600\text{V}$
I_{INLK}	V_{in} to VO leakage current @25°C	—	—	250		$V_{IN} = 600\text{V}$, $VO = 0\text{V}$
	@150°C	—	1000	—		
I_{OLK}	VO leakage current @25°C	—	—	250	V	$V_O = 600\text{V}$
	@150°C	—	1000	—		
V_{IH}	Logic "1" input voltage	2.7	—	—	μA	$V_{CC} = 10\text{V to } 20\text{V}$
V_{IL}	Logic "0" input voltage	—	—	0.8		
I_{IN+}	Logic "1" input bias current	—	20	40	V	$V_{IN} = 5\text{V}$
I_{IN-}	Logic "0" input bias current	—	—	1		
$V_{CE(on)}$	Collector-to-Emitter saturation voltage	—	3.0	—	V	$I_C = 400\text{mA}$
V_{EC}	Diode forward voltage	—	1.2	—		$I_E = 400\text{mA}$
V_F	Bootstrap Diode forward voltage (D1)	—	1.5	—		$I_F = 400\text{mA}$

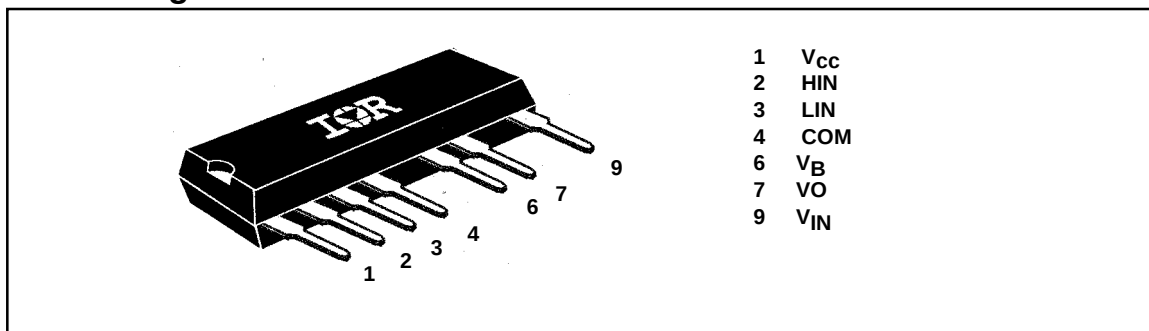
Functional Block Diagram



Lead Definitions

Lead	
Symbol	Definition
V_{CC}	Logic and internal gate drive supply voltage.
H_{IN}	Logic input for high side half bridge output, in phase
L_{IN}	Logic input for low side half bridge output, in phase (IR062xxx) or out of phase (IR082xxx)
V_B	High side gate drive floating supply
V_{IN}	High voltage supply
V_O	Half bridge output
COM	Logic return and half bridge return

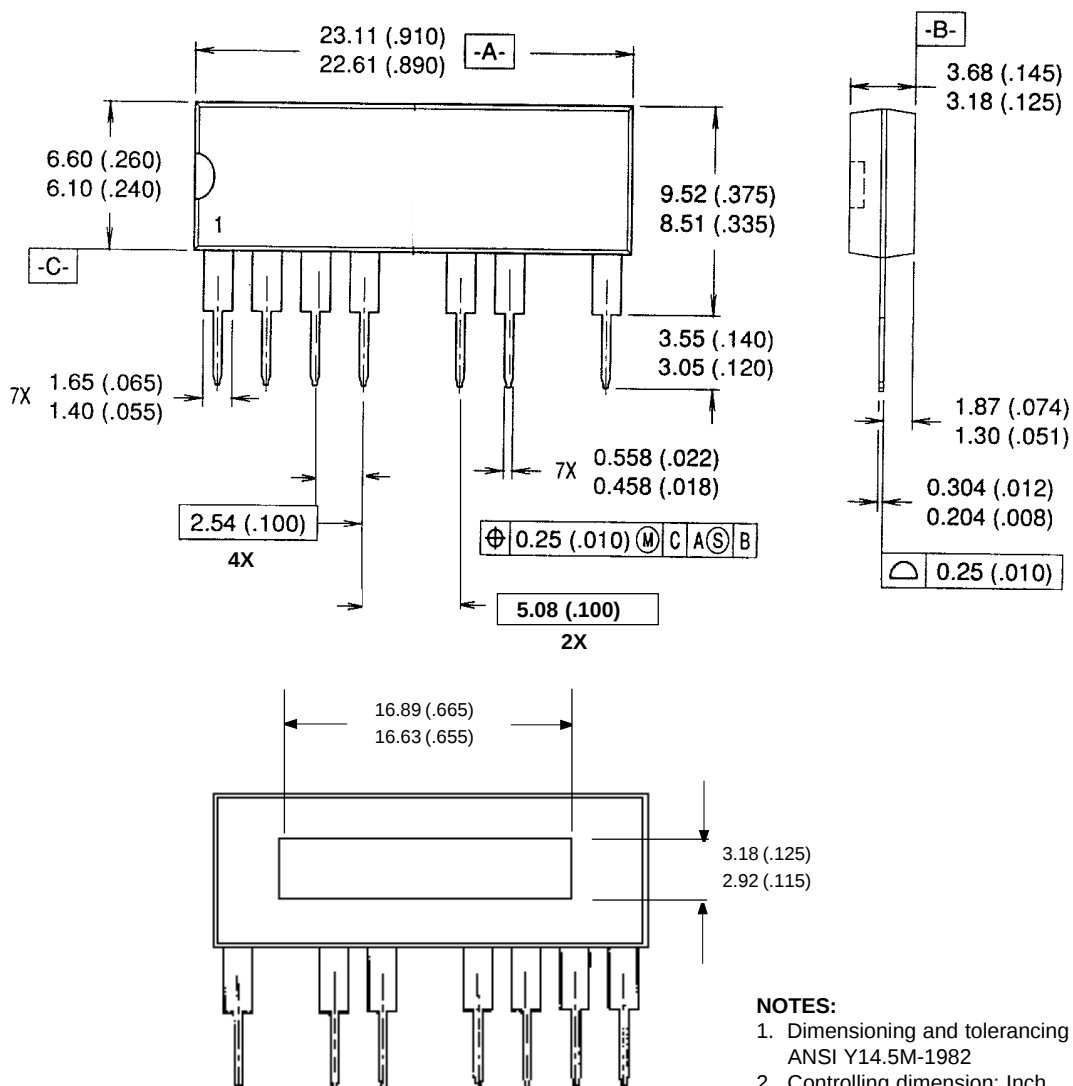
Lead Assignments



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International
IOR Rectifier

Case Outline - 7 pin



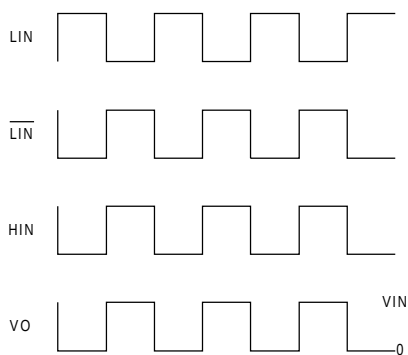


Figure 1. Input/Output Timing Diagram

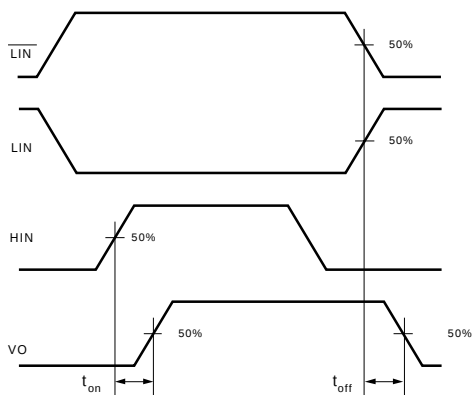


Figure 2. Switching Time Waveform Definitions